

PCB Mill - LPKF S100



This machine was acquired recently and is not yet set up for production.

Machine supports machining of all one-sided and double-sided board types in the usual packing density (FR3, FR4, FR5, G10), flexible substrates, RF substrates, drilling test adapters, structuring film patterns, producing solder frames for PCB assembly, SMD fine line technology, contour-milling, engraving of front panels or labels, depth milling of rigid or flexible boards, depaneling and reworking of populated and unpopulated boards, machining of housings and multilayers up to 8 layers in combination with MiniContac III and MultiPress-II.

Manual



s100_manual_v4.pdf



4716-circuitpro-...ides-v2-0-en.pdf



4744-release-no...2-70-270-en.pdf



4680-circuitpro-...dium-v1-2-en.pdf



1928-manual-boas...5-0-v5-0-en.pdf

Maintenance



121-technote-ma...at-s-series.pdf

Misc



4721-technote-i...system-v3-0.pdf



4506-protolaser-...g-quality-en.pdf